Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	l _D
110V	2.9mΩ@10V	220A



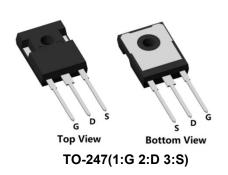
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

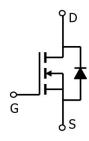
Applications

- Power switching application
- DC-DC Converter
- Power Management

Package



Circuit diagram



Marking



SP011N03AGHTF : Product code ** : Week code

Order Information

Device	Package	Unit/Tube	
SP011N03AGHTF	TO-247	30	

110V N-Channel Power MOSFET

Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	110	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (Tc=25°C)	I _D	220	А
Continuous Drain Current (Tc=100°C)	I _D	150	А
Pulsed Drain Current	I _{DM}	880	А
Single Pulse Avalanche Energy ¹	Eas	1260	mJ
Power Dissipation (Tc=25°C)	P _D	245	W
Thermal Resistance Junction-to-Case	Rejc	0.51	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	$^{\circ}$ C
Operating Junction Temperature Range	TJ	-55 to 150	℃

Electrical characteristics (Ta=25°C, unless otherwise noted)

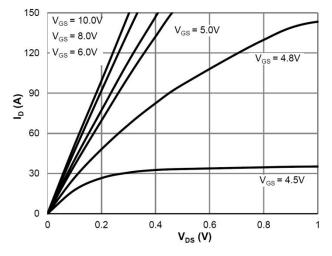
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID=250uA	110	_	-	V	
Drain Cut-Off Current	I _{DSS}	VDS=80V , VGS=0V , TJ=25℃	-	-	1		
Gate Leakage Current	Igss	VGS=±20V , VDS=0V	-	-	±0.1	μA	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250µA	2.0	3.0	4.0	V	
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 30A	-	2.9	3.7	mΩ	
Dynamic Characteristics	·		·				
Input Capacitance	C _{iss}		-	6190	-		
Output Capacitance	Coss	VDS=50V , VGS=0V , f=1MHz	-	1002	-	pF	
Reverse Transfer Capacitance	C _{rss}		-	33	-		
Total Gate Charge	Qg		-	136.5	-	nC	
Gate-Source Charge	Q _{gs}	VDS=50V , VGS=10V , ID=125A	-	46	-		
Gate-Drain Charge	Q_{gd}		-	23	-		
Switching Characteristics	Switching Characteristics						
Turn-On Delay Time	t _{d(on)}		-	22.5	-		
Rise Time	t _r	VDD=50V, VGS=10V , RG=6Ω, ID=125A	-	65	-		
Turn-Off Delay Time	t _{d(off)}	10-1200	-	75	-	nS	
Fall Time	t _f		-	26	-		
Drain-Source Body Diode Characteristics							
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 1A, VGS = 0V	-	-	1.2	V	
Maximum Body-Diode Continuous Current	Is		-	-	220	Α	
Reverse Recovery Time	Trr	l _s =50A, di/dt=100A/us, TJ=25℃	-	88	-	nS	
Reverse Recovery Charge	Qrr	15-50A, Ul/UL-100A/US, 15-25 C	-	195	-	nC	

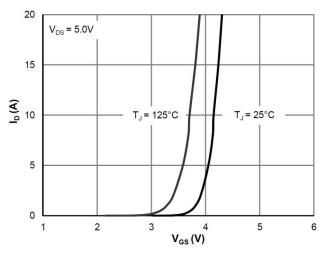
Note:

1. The test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25 Ω



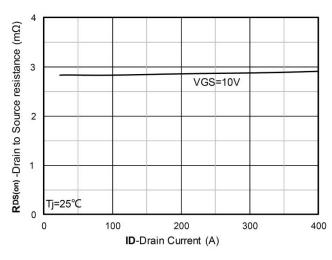
Typical Characteristics

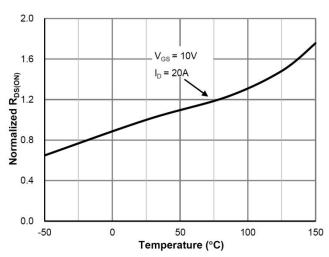






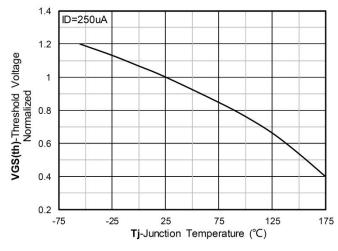


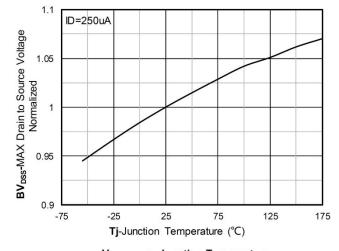




R_{DS(ON)} vs. Drain Current

R_{DS(ON)} vs. Junction Temperature

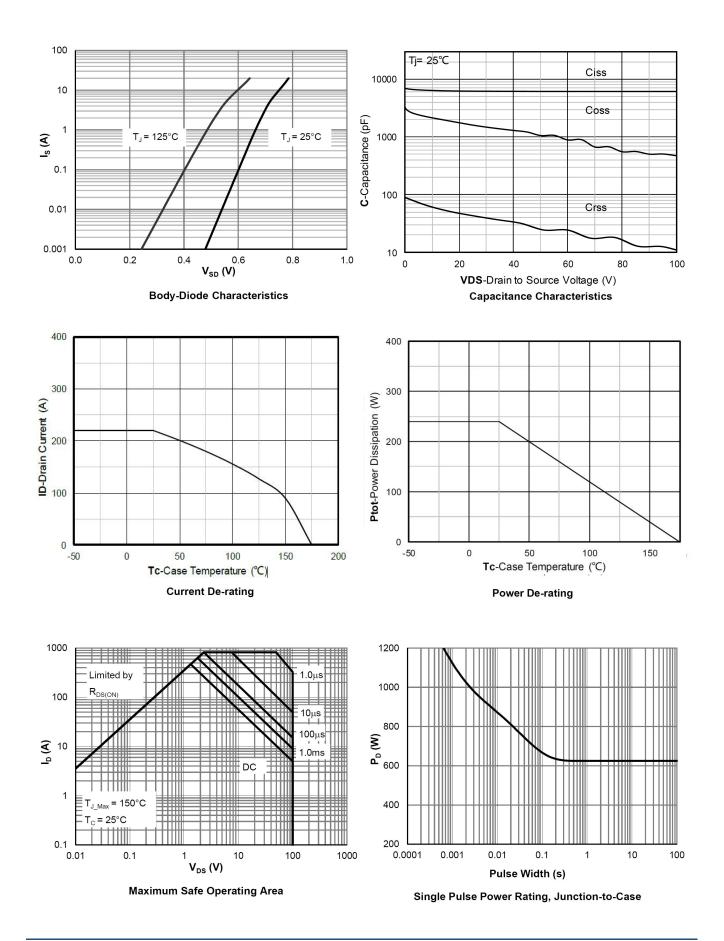




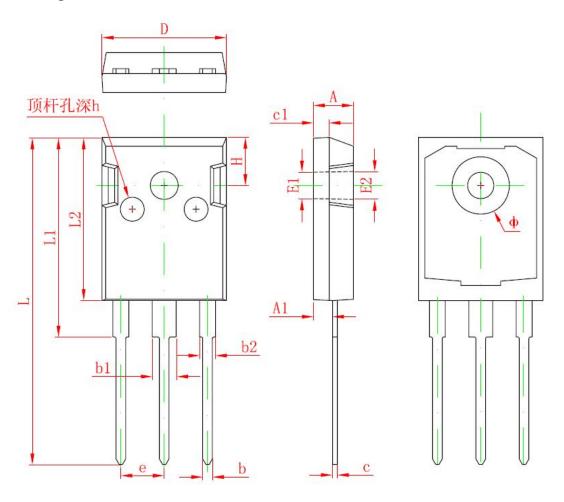
 $V_{\text{GS(th)}}$ vs. Junction Temperature

 $\mathbf{V}_{\mathsf{BR}(\mathsf{DSS})}$ vs. Junction Temperature





TO-247 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.850	5.150	0.191	0.200	
A1	2.200	2.600	0.087	0.102	
b	1.000	1.400	0.039	0.055	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
С	0.500	0.700	0.020	0.028	
c1	1.900	2.100	0.075	0.083	
D	15.450	15.750	0.608	0.620	
E1	3.50	3.500 REF.		0.138 REF.	
E2	3.60	3.600 REF.		0.142 REF.	
L	40.900	41.300	1.610	1.626	
L1	24.800	25.100	0.976	0.988	
L2	20.300	20.600	0.799	0.811	
Ф	7.100	7.300	0.280	0.287	
е	5.45	5.450 TYP.		TYP.	
Н	5.980 REF.		0.235 REF.		
h	0.000	0.300	0.000	0.012	